



Product Specification

AU OPTRONICS CORPORATION

() Preliminary Specifications

(✓) Final Specifications

Module	12.5"(12.49") FHD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B125HAN02.2 (H/W: 0A)
Note ()	LED Backlight with driving circuit design

Customer

Date

Checked &
Approved by

Date

Note: This Specification is subject to
change without notice.

Approved by

Date

Trista Jiang

07/28/2015

Prepared by

Date

Tina GT Lin

07/28/2015

**MPBU Marketing Division
AU Optronics corporation**

2. General Description

B125HAN02.2 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 FHD, 1920(H) x1080(V) screen and 16.7k colors (RGB 6-bits data with FRC) with LED backlight driving circuit. All input signals are eDP(Embedded Display Port) interface compatible.

B125HAN02.2 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 °C condition:

Items	Unit	Specifications			
Screen Diagonal	[mm]	317.5			
Active Area	[mm]	276.48 X 155.52			
Pixels H x V		1920x3(RGB) x 1080			
Pixel Pitch	[mm]	0.144X0.144			
Pixel Format		R.G.B. Vertical Stripe			
Display Mode		Normally Black			
White Luminance (ILED=19mA) (Note: ILED is LED current)	[cd/m ²]	300typ. (5 points average) 255 min. (5 points average)			
Luminance Uniformity		1.25 max. (5 points)			
Contrast Ratio		700 typ			
Response Time	[ms]	25typ / 35 Max			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.			
Power Consumption	[Watt]	2.83 max. (Include Logic and Blu power)			
Weight	[Grams]	170 max.			
Physical Size Include bracket	[mm]		Min.	Typ.	Max.
		Length	281.9	282.4	282.9
		Width	178.82	179.32	178.82
		Thickness		-	2.3/2.5
Electrical Interface		2 lane eDP 1.3			
Glass Thickness	[mm]	0.2			
Surface Treatment		AG			
Support Color		16.7K colors (RGB 6-bits data with FRC)			
Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60			
RoHS Compliance		RoHS Compliance			



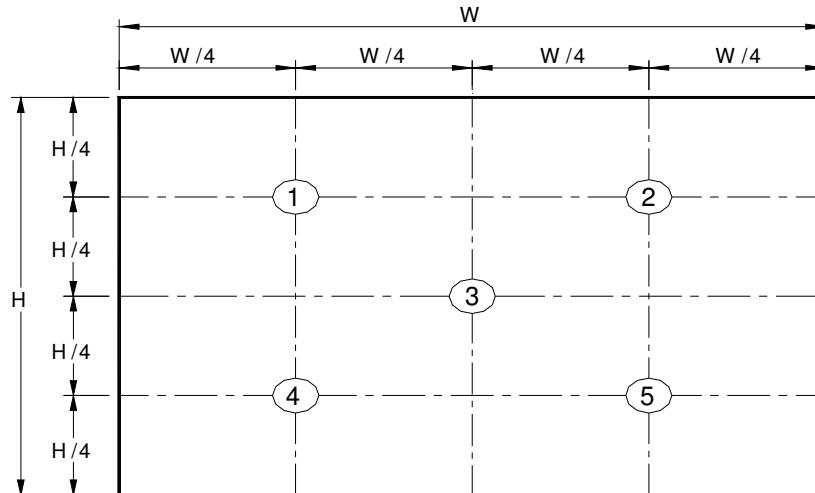
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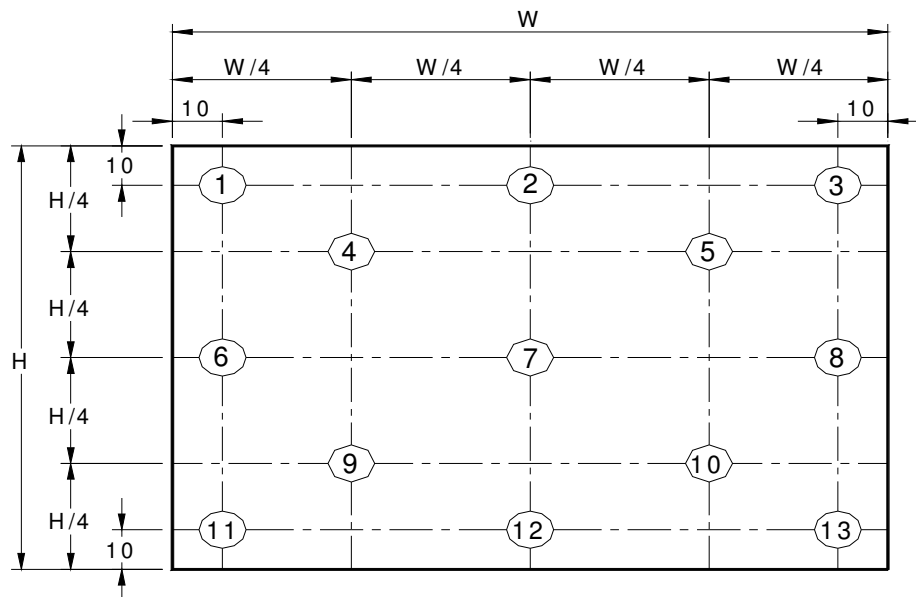
2.2 Optical Characteristics

Item		Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
White Luminance ILED=19mA			5 points average	255	300	-	cd/m²	1, 4, 5.
Viewing Angle		θ _R θ _L	Horizontal (Right) CR = 10 (Left)	80	85	-	degree	4, 9
				80	85			
		ψ _H ψ _L	Vertical (Upper) CR = 10 (Lower)	80	85	-		
				80	85			
Luminance Uniformity		δ _{5P}	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ _{13P}	13 Points	-	-	1.60		2, 3, 4
Contrast Ratio		CR		-	700	-		4, 6
Cross talk		%		-	-	4		4, 7
Response Time		T _{RT}	Rising + Falling	-	25	35	msec	4, 8
Color / Chromaticity Coodinates	Red	R _x	CIE 1931	0.552	0.582	0.612		4
		R _y		0.319	0.349	0.379		
	Green	G _x		0.315	0.345	0.375		
		G _y		0.558	0.588	0.618		
	Blue	B _x		0.128	0.158	0.188		
		B _y		0.083	0.113	0.143		
	White	W _x		0.283	0.313	0.343		
		W _y		0.299	0.329	0.359		
	NTSC			%		-		

Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

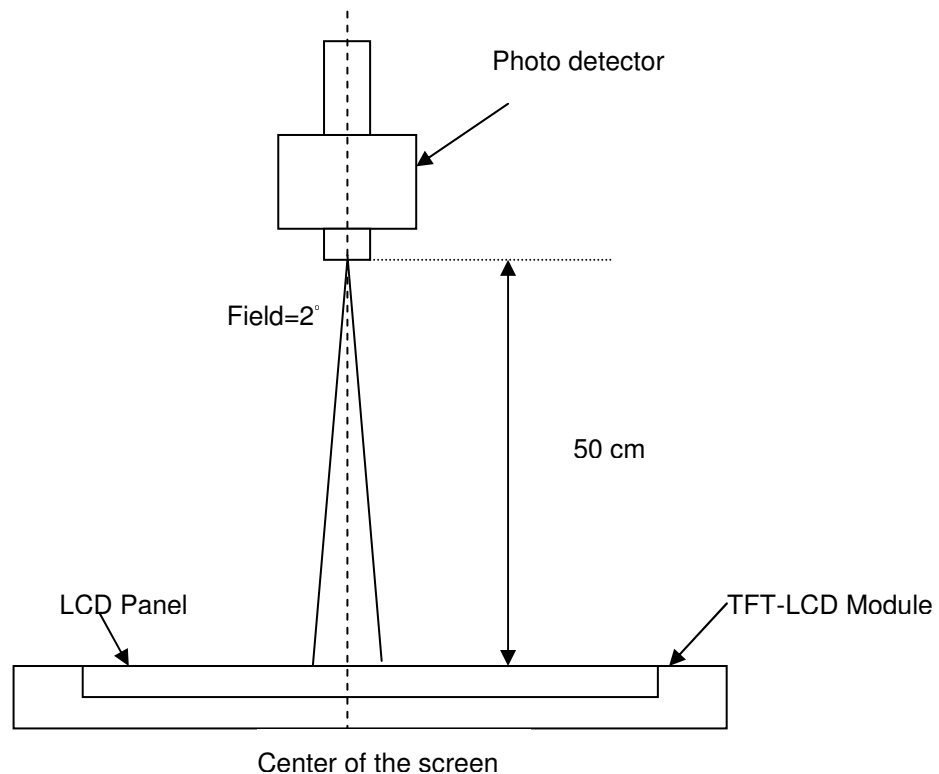
$$\delta_{W5} = \frac{\text{Maximum Brightness of five points}}{\text{Minimum Brightness of five points}}$$

$$\delta_{W13} = \frac{\text{Maximum Brightness of thirteen points}}{\text{Minimum Brightness of thirteen points}}$$

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should

be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5 : Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points · $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$

$L(x)$ is corresponding to the luminance of the point X at Figure in Note (1).

Note 6 : Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the "White" state}}{\text{Brightness on the "Black" state}}$$

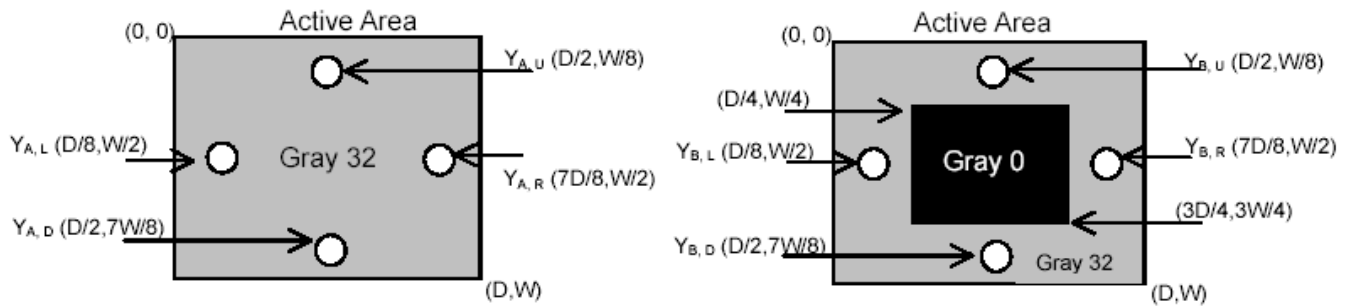
Note 7 : Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

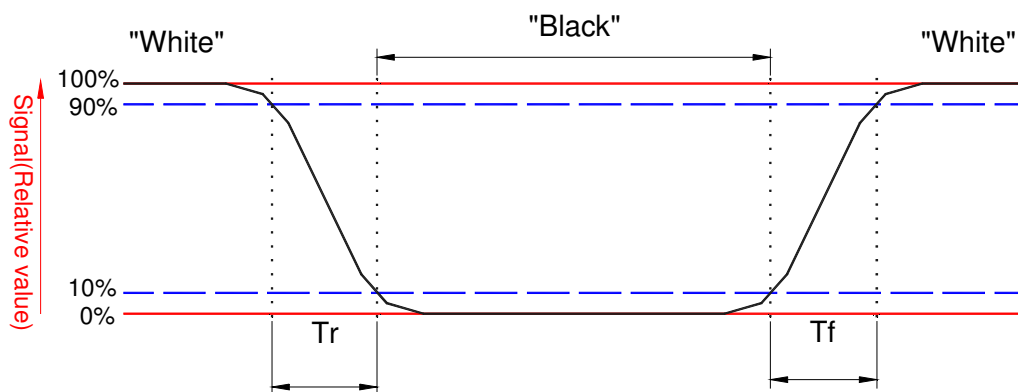
Y_A = Luminance of measured location without gray level 0 pattern (cd/m²)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m²)



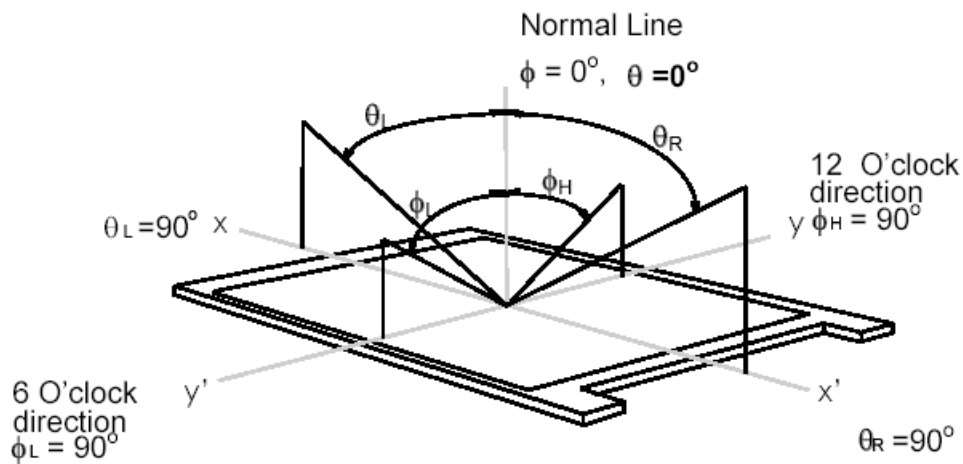
Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.



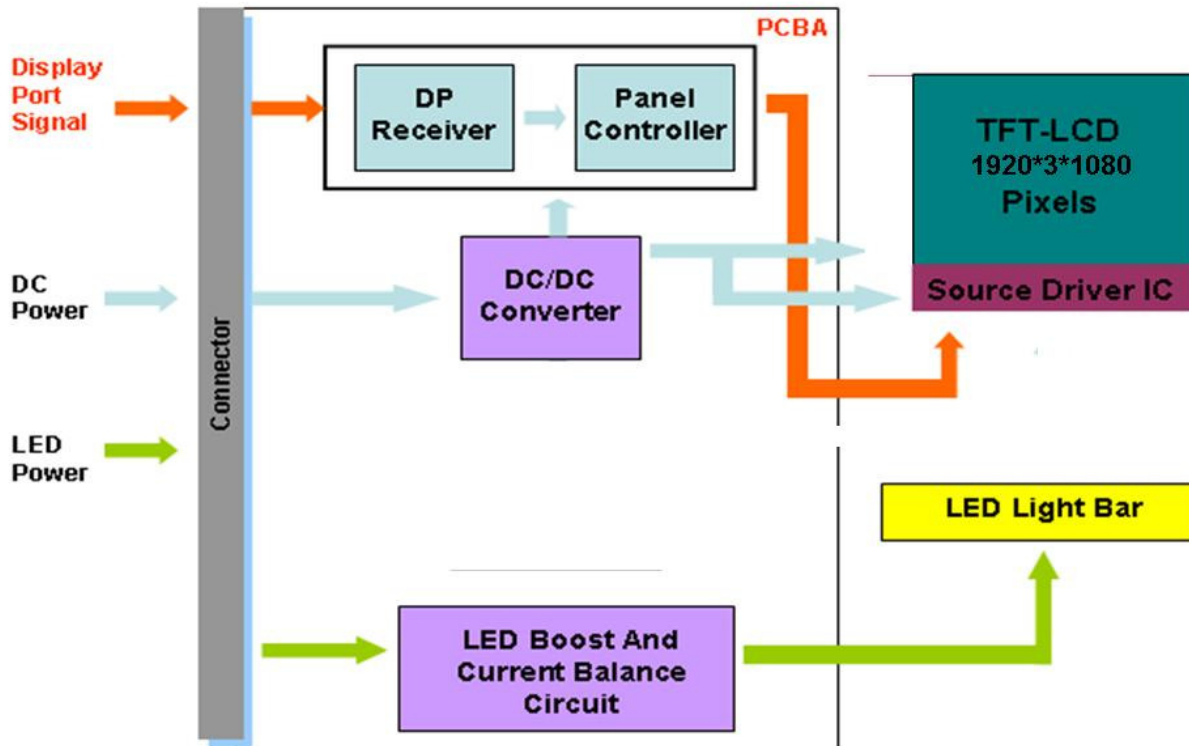
Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio ≥ 10 , at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (ϕ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



3. Functional Block Diagram

The following diagram shows the functional block of the 12.5 inches wide Color TFT/LCD 30 Pin



4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

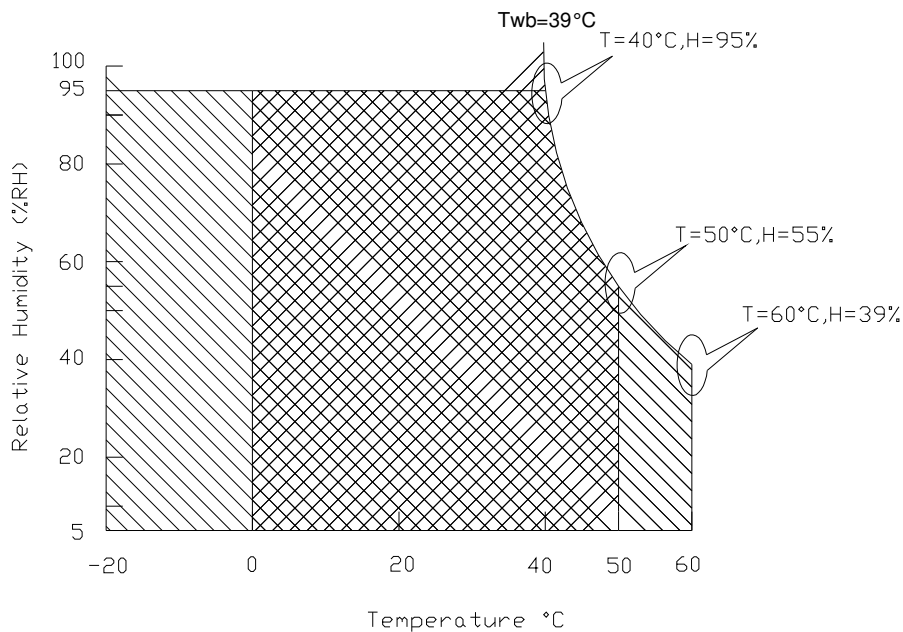
Item	Symbol	Min	Max	Unit	Conditions
Operating	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)

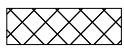
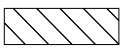
Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range 

Storage Range  + 

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows;

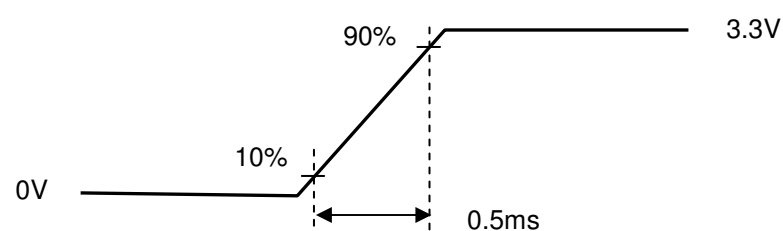
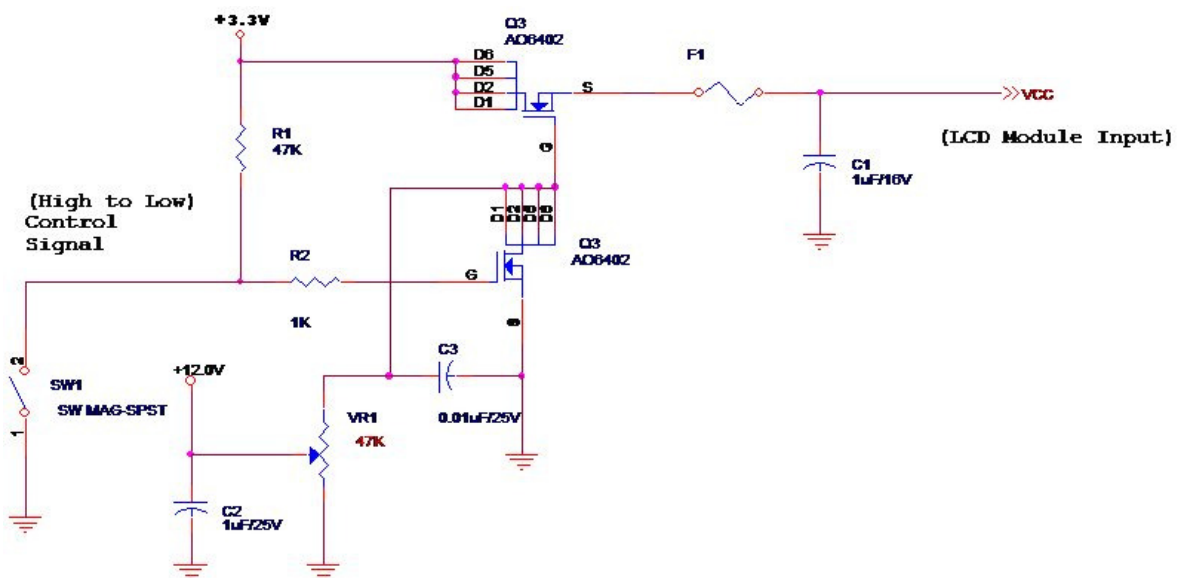
The power specification are measured under 25°C and frame frequency under 60Hz

Symble	Parameter	Min	Typ	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	1.0	1.0	[Watt]	Note 1
IDD	IDD Current	-	303	303	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : White Pattern at 3.3V driving voltage. ($P_{max}=V_{3.3} \times I_{black}$)

Typical Measurement Condition : Mosaic Pattern

Note 2 : Measure Condition

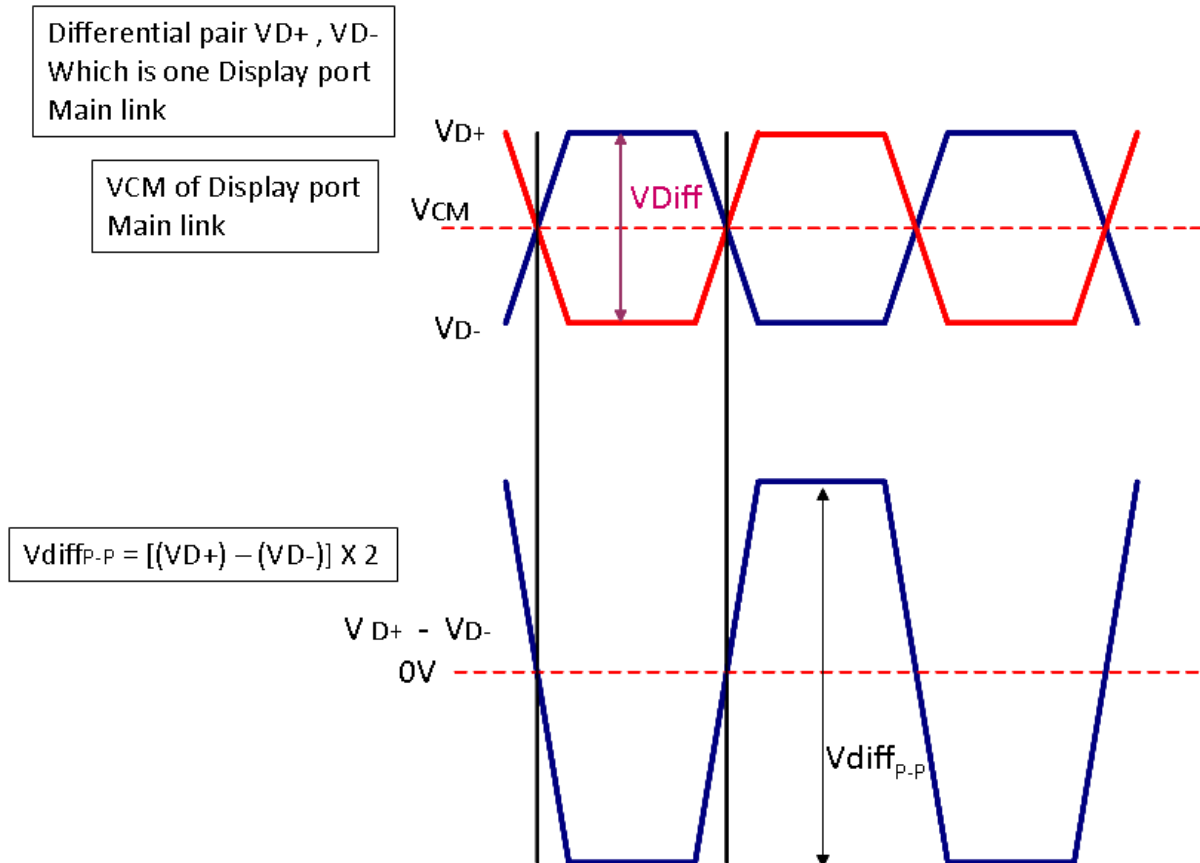


5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

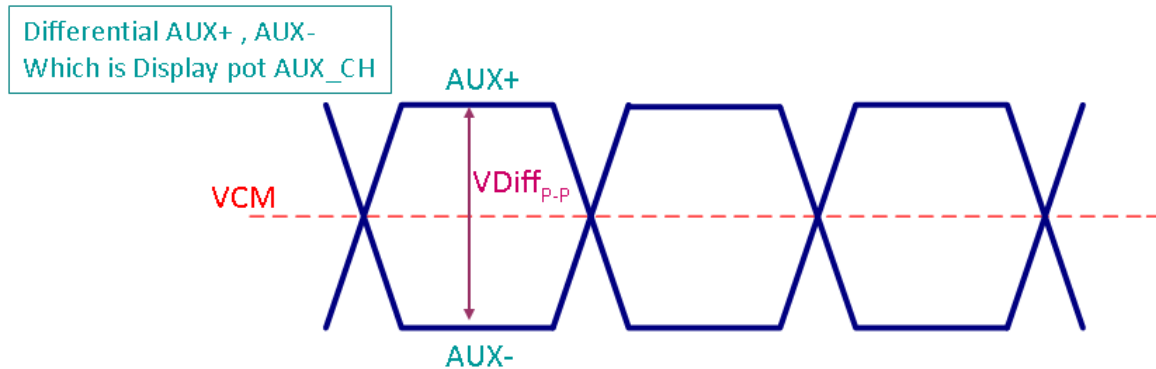
Display Port main link signal:



Display port main link					
		Min	Typ	Max	unit
VCM	RX input DC Common Mode Voltage		0		V
VDiff _{P-P}	Peak-to-peak Voltage at a receiving Device	100		1320	mV

Follow as VESA display port standard V1.2

Display Port AUX_CH signal:



Display port AUX_CH					
		Min	Typ	Max	unit
VCM	AUX DC Common Mode Voltage		0		V
VDiff _{P-P}	AUX Peak-to-peak Voltage at a receiving Device	0.4	0.6	0.8	V

Follow as VESA display port standard V1.2.

Display Port VHPD signal:

Display port VHPD					
		Min	Typ	Max	unit
VHPD	HPD Voltage	2.25		3.6	V

Follow as VESA display port standard V1.2.



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5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol	Min	Typ	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	1.83	[Watt]	(Ta=25°C), Note 1 Vin = 12V
LED Life-Time	N/A	12,000	-	-	Hour	(Ta=25°C), Note 2 If=19 mA

Note 1: Calculator value for reference $P_{LED} = V_F$ (Normal Distribution) * I_F (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Typ	Max	Units	Remark
LED Power Supply	VLED	5.0	12.0	21.0	[Volt]	Define as Connector Interface (Ta=25°C)
LED Enable Input High Level	VLED_EN	2.2	-	5.5	[Volt]	
LED Enable Input Low Level		-	-	0.5	[Volt]	
PWM Logic Input High Level	VPWM_EN	2.2	-	5.5	[Volt]	
PWM Logic Input Low Level		-	-	0.5	[Volt]	
PWM Input Frequency	FPWM	200	1K	10K	Hz	
PWM Duty Ratio	Duty	1 Note 2	-	100	%	

Note 1 : Recommend system pull up/down resistor no bigger than 10kohm

Note 2 : If the PWM duty ratio(min) is set between 5% to 1% · the PWM input frequency should be set below 1KHz . The brightness-duty characteristic might not be able to keep in it's linearity if the dimming control is operated in 1% to 5% range.



6.2 Integration Interface Requirement

6.2.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

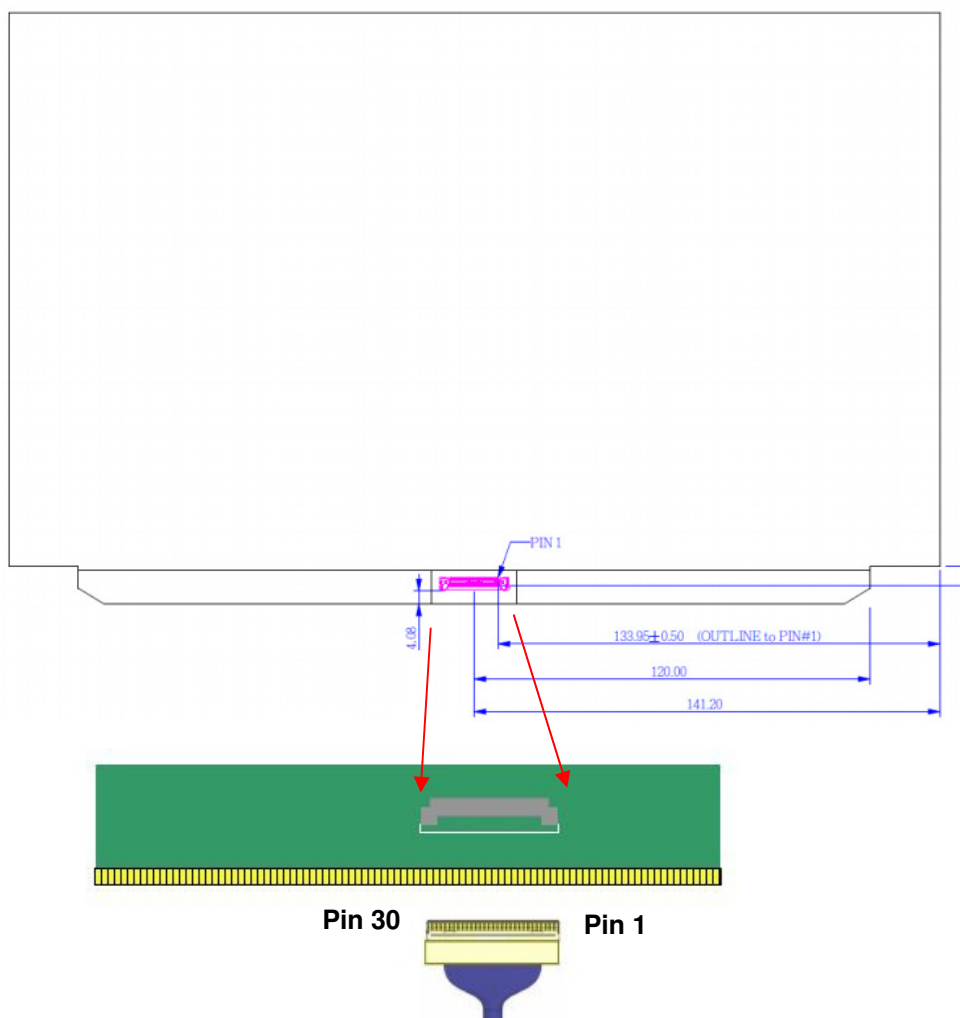
Connector Name / Designation	For Signal Connector
Manufacturer	Hirose
Type / Part Number	KN38A-30S-0.5H(800)
Mating Housing/Part Number	Hirose

6.2.2 Pin Assignment (2 Lane)

eDP lane is a differential signal technology for LCD interface and high speed data transfer device.

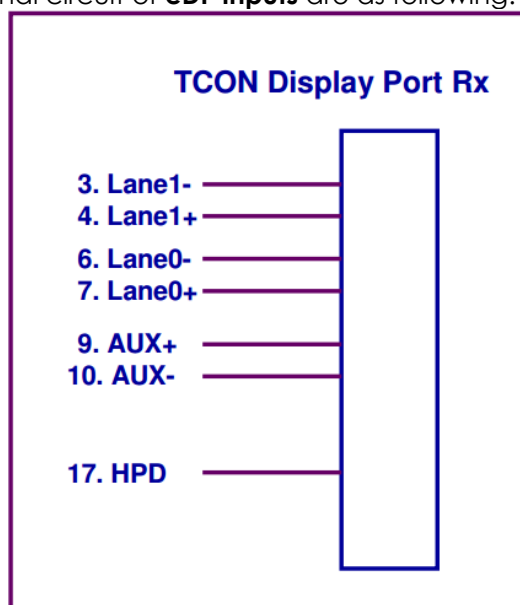
PIN NO	Symbol	Function
1	GPIO_PSR	GPIO_PSR Function
2	H_GND	High Speed Ground
3	Lane1_N	Comp Signal Link Lane 1
4	Lane1_P	True Signal Link Lane 1
5	H_GND	High Speed Ground
6	Lane0_N	Comp Signal Link Lane 0
7	Lane0_P	True Signal Link Lane 0
8	H_GND	High Speed Ground
9	AUX_CH_P	True Signal Auxiliary Ch.
10	AUX_CH_N	Comp Signal Auxiliary Ch.
11	H_GND	High Speed Ground
12	LCD_VCC	LCD logic and driver power
13	LCD_VCC	LCD logic and driver power
14	LCD_Self_Test	LCD Panel Self Test Enable
15	LCD_GND	LCD logic and driver ground
16	LCD_GND	LCD logic and driver ground
17	HPD	HPD signale pin
18	BL_GND	Backlight ground
19	BL_GND	Backlight ground
20	BL_GND	Backlight ground
21	BL_GND	Backlight ground
22	BL_Enable	Backlight On / Off
23	BL_PWM_DIM	System PWM signal Input
24	H_SYNC	H_SYNC. Function (VH 2.0V min, VL 0.5V max)
25	NC	Reserved for LCD manufacture's use
26	BL_PWR	Backlight power
27	BL_PWR	Backlight power
28	BL_PWR	Backlight power
29	BL_PWR	Backlight power
30	NC	NC

eDP lane is a differential signal technology for LCD interface and high speed data transfer device.



Note1: Start from right side.

Note2: Input signals shall be low or High-impedance state when VDD is off.
Internal circuit of **eDP inputs** are as following.



6.3 Interface Timing

6.3.1 Timing Characteristics

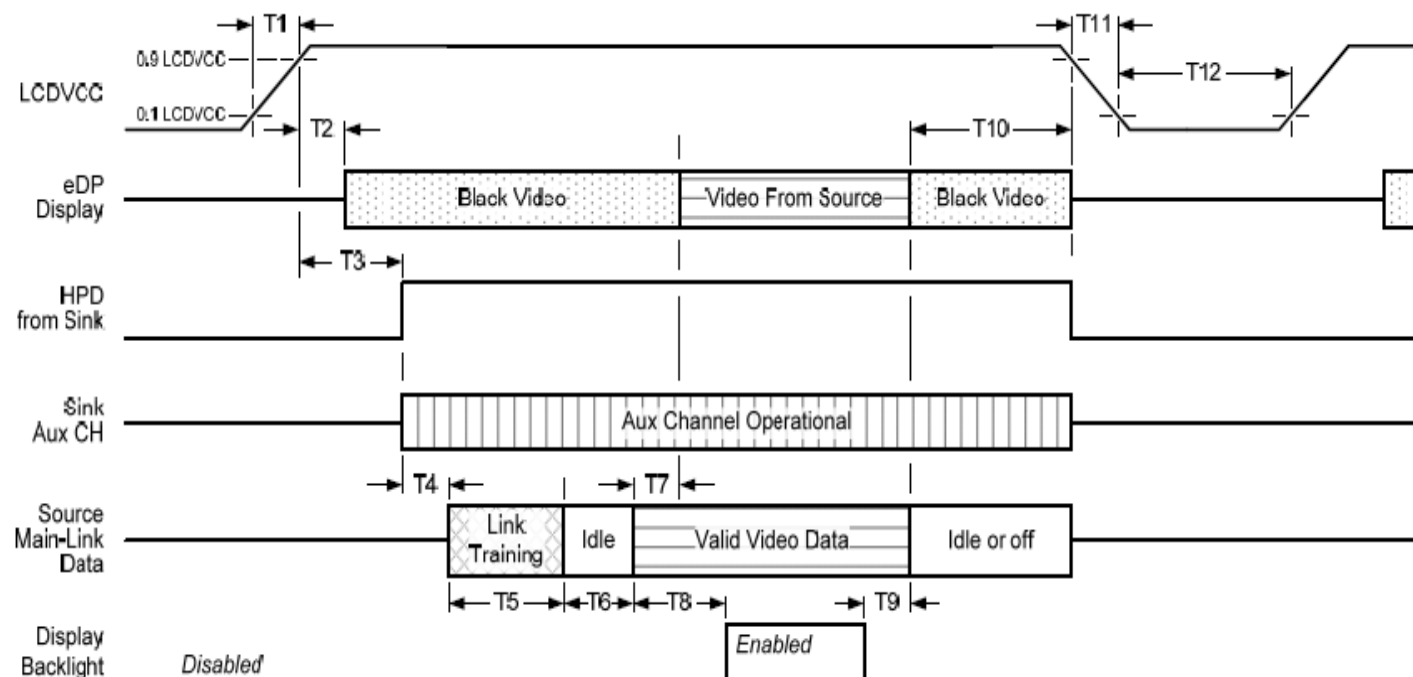
Basically, interface timings should match the 1920X1080 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Typ.	Max.	Unit
Frame Rate		-	-	60	-	Hz
Clock frequency		1/ T _{Clock}	-	141	-	MHz
Vertical Section	Period	T _V	1090	1116	3080	T _{Line}
	Active	T _{VD}	1080			
	Blanking	T _{VB}	10	36	2000	
Horizontal Section	Period	T _H	2000	2104	2320	T _{Clock}
	Active	T _{HD}	1920			
	Blanking	T _{HB}	80	184	400	

Note 1 : The frame rate will be set to 48HZ when PSR function is turned on.

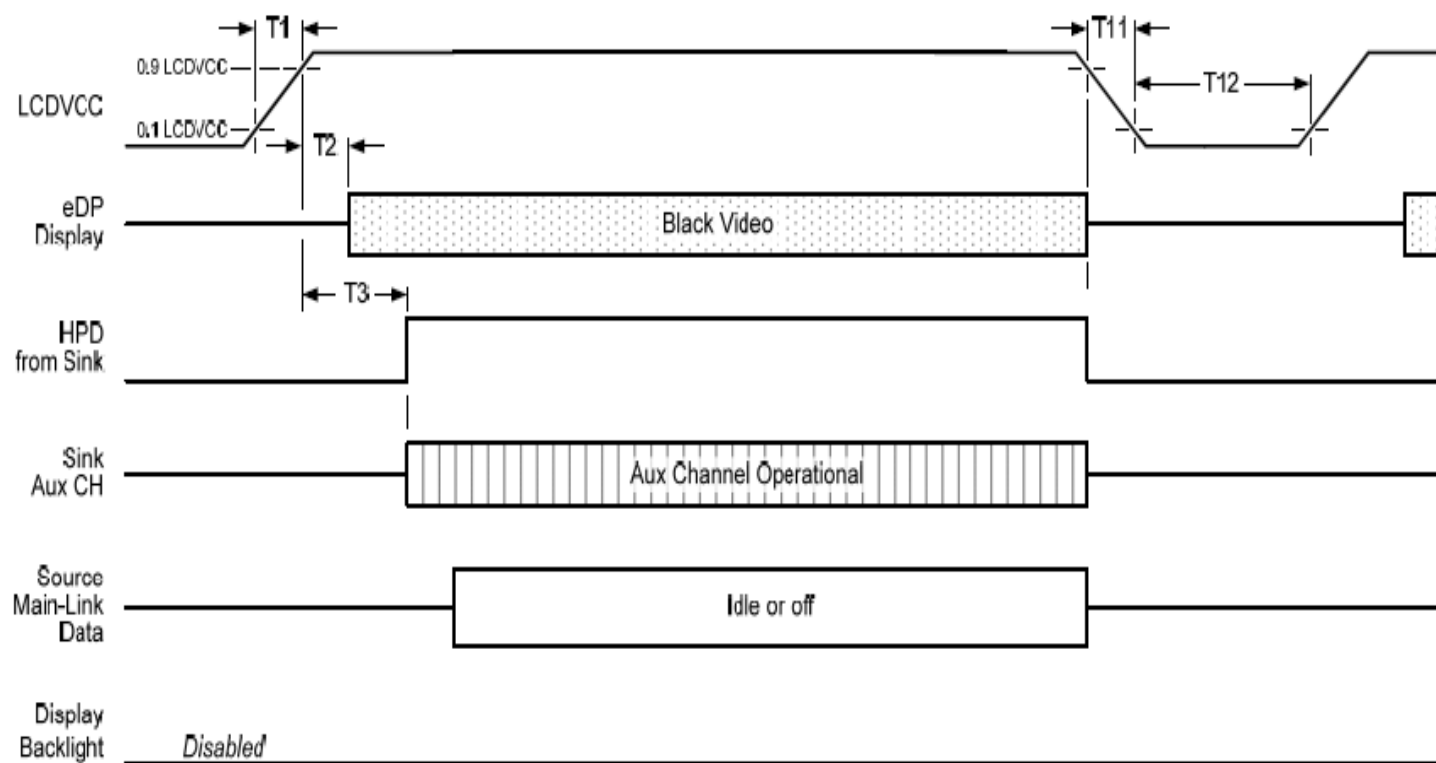
6.4 Power ON/OFF Sequence

Display Port panel power sequence:



Display port interface power up/down sequence, normal system operation

Display Port AUX_CH transaction only:



Display port interface power up/down sequence, AUX_CH transaction only

Display Port panel power sequence timing parameter:

Timing parameter	Description	Reqd. by	Limits			Notes
			Min.	Typ.	Max.	
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms	
T2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source
T3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.
T4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.
T5	link training duration	source				dependant on source link to read training protocol.
T6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.
T7	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.
T8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.
T9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.
T10	delay from end of valid video data from source to power off	source	0ms		500ms	
T11	power rail fall time, 90% to 10%	source			10ms	
T12	power off time	source	150ms			

Note 1: The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:

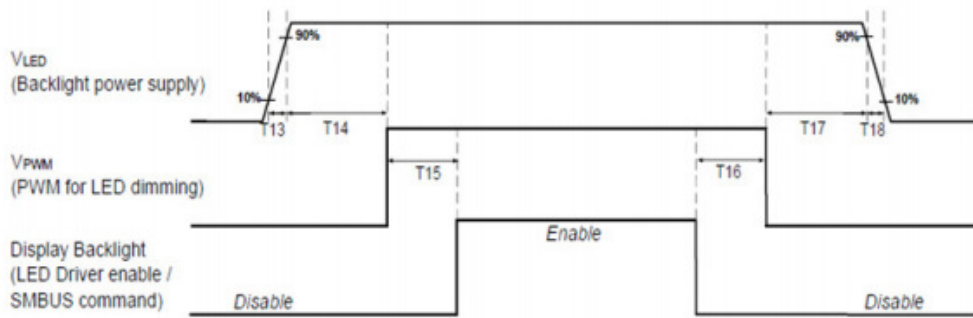
- upon LCDVDD power on (within T2 max)-when the "Novideostream_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).

- when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

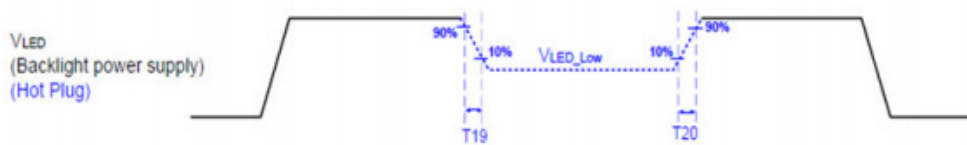
Note 2: The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

Note 3: The sink must support AUX_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX_CH transaction with the time specified within T3 max.

Display Port panel B/L power sequence timing parameter:



Note : When the adapter is hot plugged, the backlight power supply sequence is shown as below.



Note : If $T19, T20 < 5 \times T_{PWM}^*$ - The flash display may occur. We suggest $T19, T20 \geq 5 \times T_{PWM}^*$ to realize seamless change display.

	Min (ms)	Max (ms)
T13	0.2	-
T14	0	-
T15	-	-
T16	-	-
T17	0	-
T18	0	-
T19	1*	-
T20	1*	-

Seamless change: $T19/T20 = 5 \times T_{PWM}^*$

* $T_{PWM} = 1/P_{PWM}$ Frequency

Note 1 : If $T14, T15, T16, T17 < 10ms$, The display garbage may occur. We suggest $T14, T15, T16, T17 > 10ms$ to avoid the display garbage.

Note 2 : If $T13$ or $T18 < 0.5ms$, the inrush current may cause the damage of fuse. If $T13$ or $T18 < 0.5ms$, the inrush current I_{2t} is under typical melt of fuse Spec. , there is no mentioned problem.

7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 1.5 G
- Frequency: 10 - 500Hz Random
- Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 220 G , Half sine wave
- Active time: 2 ms
- Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

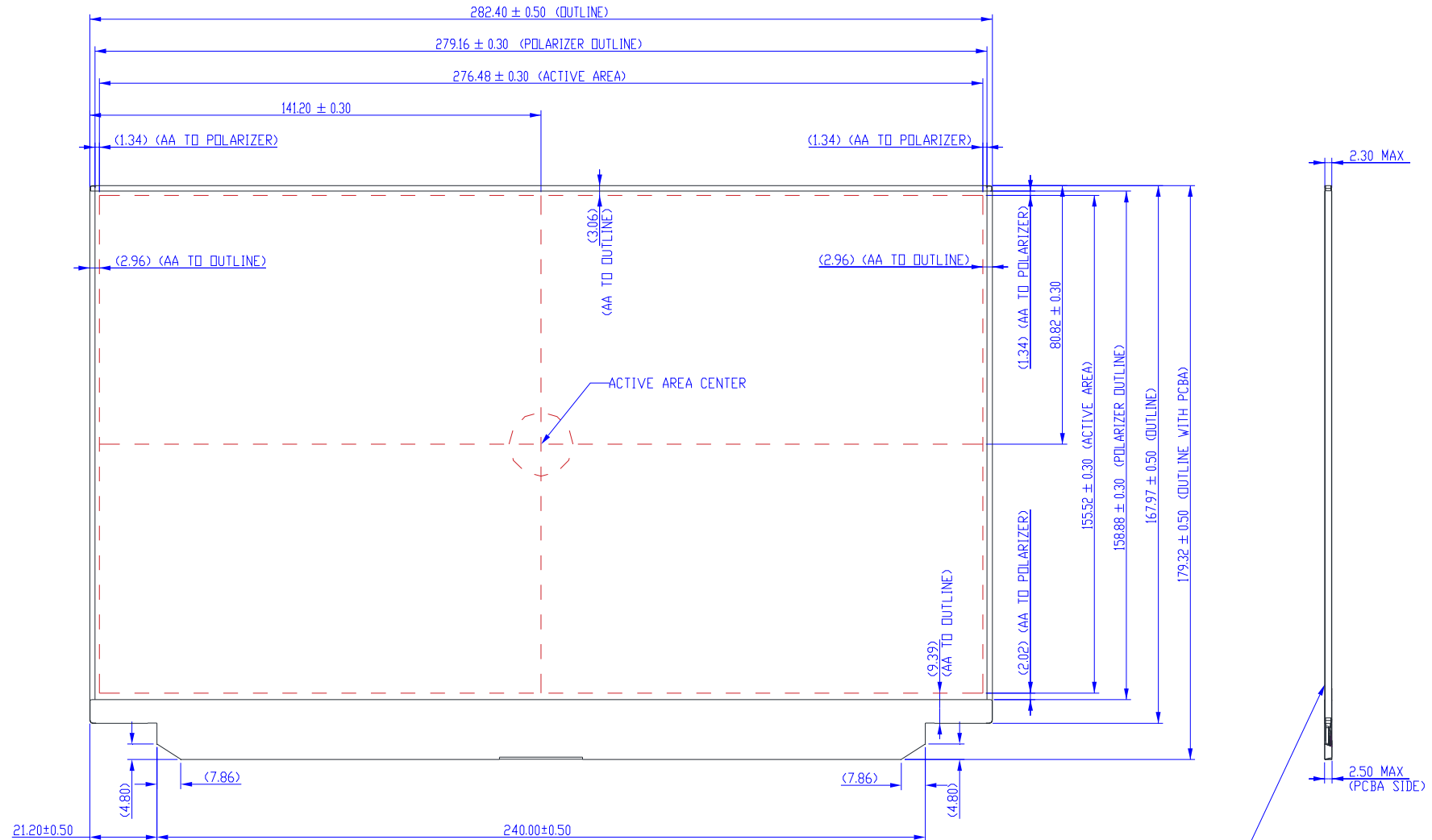
Note1: According to EN 61000-4-2 , ESD class B: Some performance degradation allowed.
Self-recoverable.

No data lost, No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

8. Mechanical Characteristics

8.1 LCM Outline Dimension

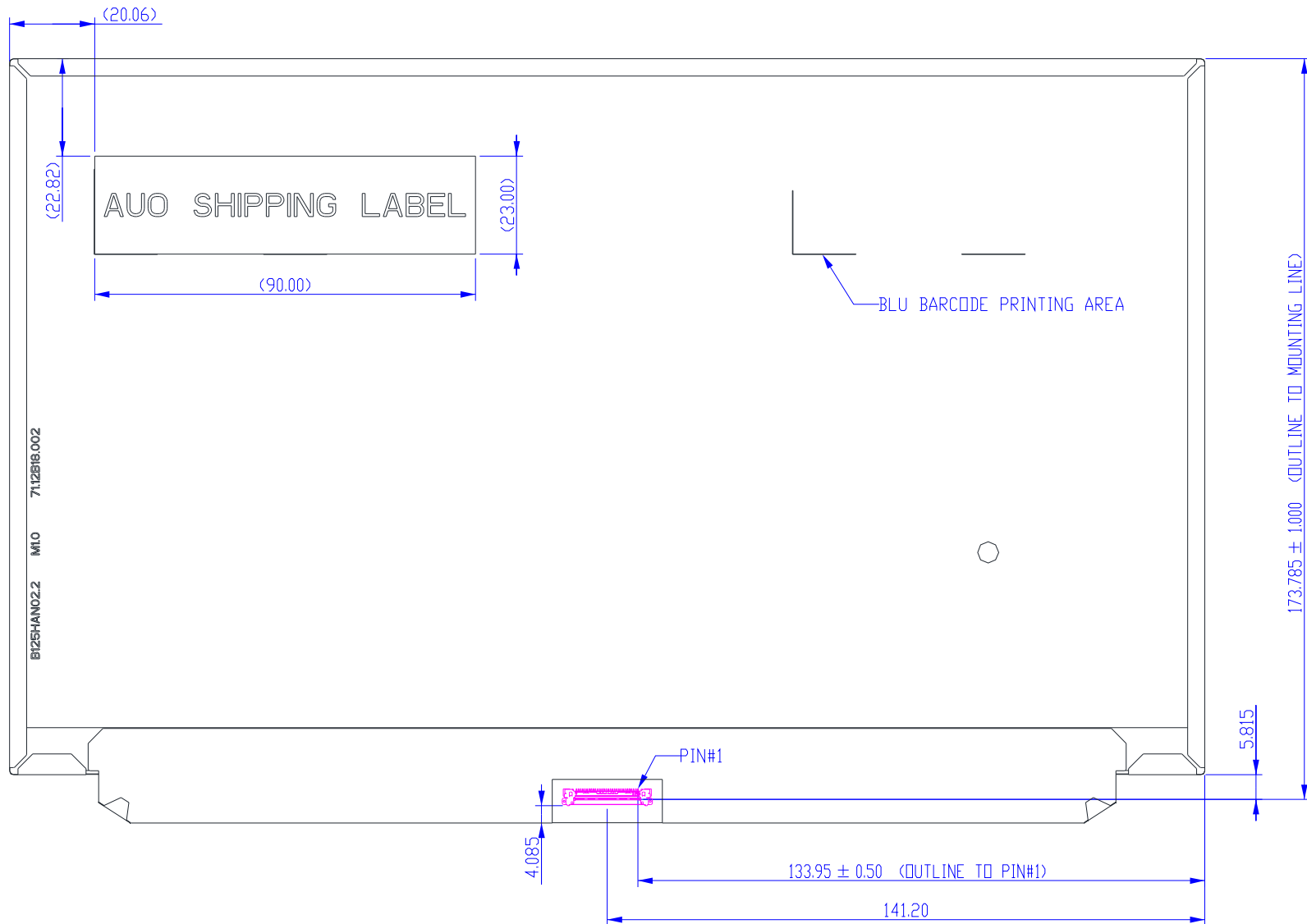


LCD MODULE'S HIGHEST PORTION IS THE TOP POLARIZER.
AND ANY OTHER LCM MATERIAL/COMPONENT IS LOWER THAN THE TOP POLARIZER.



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Note: Prevention IC damage, IC positions not allowed any overlap over these areas

9. Shipping and Package

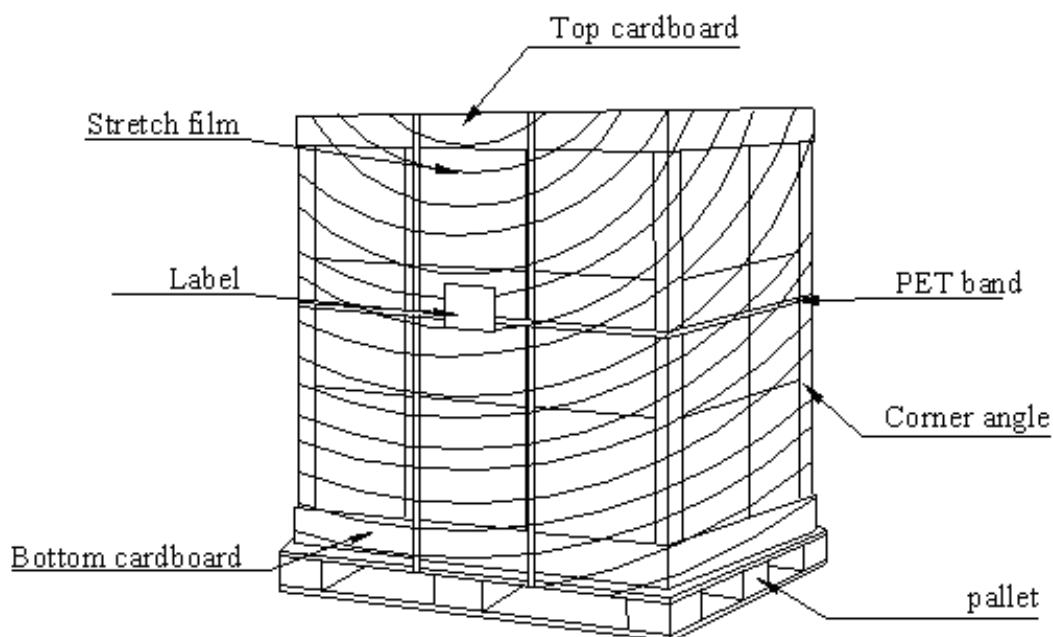
9.1 Shipping Label Format

 XXXXXXXXXXXX-XXXXX	Manufactured MM/WW Model No: B125HAN02.2 AU Optronics MADE IN China (S06) H/W: 0A F/W: 1	c  us E204354  RoHS 
 8S SD10G56682 A 1 SZYMD XXXX P/N SD10G56682 FRU 00HN883		

9.2 Carton Package



9.3 Shipping Package of Palletizing Sequence





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10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	6D	01101101	109	
0B	hex, LSB first	22	00100010	34	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	19	00011001	25	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	A5	10100101	165	
15	Max H image size (rounded to cm)	1C	00011100	28	
16	Max V image size (rounded to cm)	10	00010000	16	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	16	00010110	22	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	85	10000101	133	
1B	Red x (Upper 8 bits)	95	10010101	149	
1C	Red y/ highER 8 bits	59	01011001	89	
1D	Green x	58	01011000	88	
1E	Green y	96	10010110	150	
1F	Blue x	28	00101000	40	
20	Blue y	1D	00011101	29	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	00000001	1	
28	Standard timing #2	01	00000001	1	
29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	



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2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	14	00010100	20	
37	Pixel Clock/10000 USB	37	00110111	55	
38	Horz active Lower 8bits	80	10000000	128	
39	Horz blanking Lower 8bits	B8	10111000	184	
3A	HorzAct:HorzBlnk Upper 4:4 bits	70	01110000	112	
3B	Vertical Active Lower 8bits	38	00111000	56	
3C	Vertical Blanking Lower 8bits	24	00100100	36	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	40	01000000	64	
3E	HorzSync. Offset	10	00010000	16	
3F	HorzSync.Width	10	00010000	16	
40	VertSync.Offset : VertSync.Width	3E	00111110	62	
41	Horz&Vert Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	14	00010100	20	
43	Vertical Image Size Lower 8bits	9B	10011011	155	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border <i>(zero for internal LCD)</i>	00	00000000	0	
46	Vertical Border <i>(zero for internal LCD)</i>	00	00000000	0	
47	Signal <i>(non-intr, norm, no stero, sep sync, neg pol)</i>	18	00011000	24	
48	Detailed timing/monitor	10	00010000	16	
49	descriptor #2	2C	00101100	44	
4A		80	10000000	128	
4B		B8	10111000	184	
4C		70	01110000	112	
4D		38	00111000	56	
4E		24	00100100	36	
4F		40	01000000	64	
50		10	00010000	16	
51		10	00010000	16	
52		3E	00111110	62	
53		00	00000000	0	
54		14	00010100	20	
55		9B	10011011	155	
56		10	00010000	16	
57		00	00000000	0	
58		00	00000000	0	
59		18	00011000	24	



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5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	A
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	O
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	B
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	32	00110010	50	2
74	Manufacture P/N	35	00110101	53	5
75	Manufacture P/N	48	01001000	72	H
76	Manufacture P/N	41	01000001	65	A
77	Manufacture P/N	4E	01001110	78	N
78	Manufacture P/N	30	00110000	48	0
79	Manufacture P/N	32	00110010	50	2
7A	Manufacture P/N	2E	00101110	46	.
7B	Manufacture P/N	32	00110010	50	2
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	C8	11001000	200	